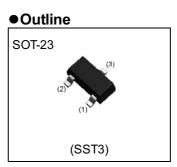


NPN 100mA 50V Digital Transistor (Bias Resistor Built-in Transistor)

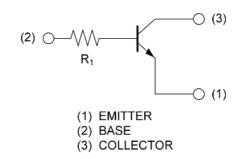
Parameter	Value
V _{CEO}	50V
۱ _C	100mA
R ₁	4.7kΩ



Inner circuit

Features

- 1) Built-In Biasing Resistor
- Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary PNP Types: DTA143TCA



Application

INVERTER, INTERFACE, DRIVER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTC143TCA	SOT-23 (SST3)	2924	T116	180	8	3000	03

● Absolute maximum ratings (T_a = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	V _{CBO}	50	V
Collector-emitter voltage	V _{CEO}	50	V
Emitter-base voltage	V _{EBO}	5	V
Collector current	Ι _C	100	mA
Device disain ation	P _D *1	200	mW
Power dissipation	P _D *2	350	mW
Junction temperature	Tj	150	°C
Range of storage temperature	T _{stg}	-55 to +150	°C

• Electrical characteristics ($T_a = 25^{\circ}C$)

Deremeter	Symbol	Conditions	Values			1.1:4
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO} I _C = 50μA		50	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	BV _{CEO} I _C = 1mA		-	-	V
Emitter-base breakdown voltage	BV_{EBO}	Ι _Ε = 50μΑ	5	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = 50V	-	-	500	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 4V	-	-	500	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 5mA, I _B = 0.25mA	-	-	300	mV
DC current gain	h _{FE}	V _{CE} = 5V, I _C = 1mA	100	250	600	-
Input resistance	R ₁	-	3.29	4.7	6.11	kΩ
Transition frequency	f _T *3	V _{CE} = 10V, I _E = -5mA, f = 100MHz	-	250	-	MHz

*1 Each terminal mounted on a reference land.

*2 Mounted on a ceramic board(7.0×5.0×0.6mm).

*3 Characteristics of built-in transistor



●Electrical characteristic curves (T_a =25°C)

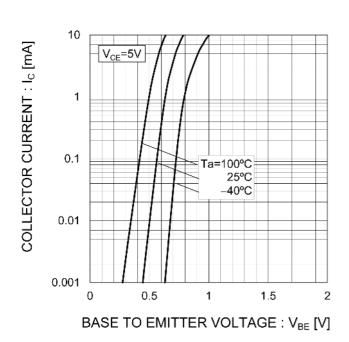
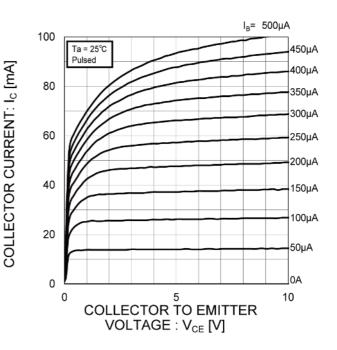


Fig.1 Grounded emitter propagation characteristics

Fig.2 Grounded emitter output characteristics



DC CURRENT GAIN : hFE

1k

500

200

100

50

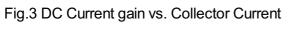
20

10

5

2

1



Ta=100°C

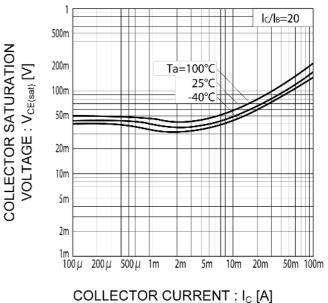
2m

COLLECTOR CURRENT : Ic [A]

5m

25°C -40°C

Fig.4 Collector-emitter saturation voltage vs. Collector Current



50m 100m

V_{CE} = 5V

Pulsed

20m

10m

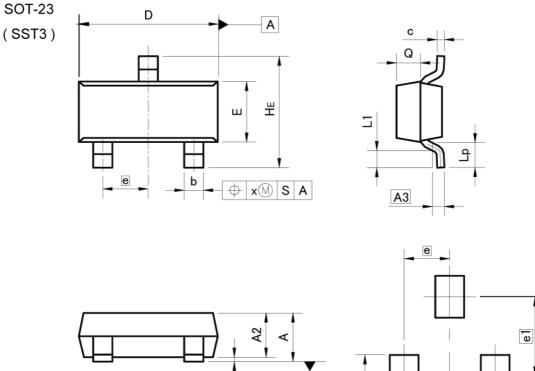
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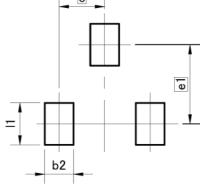
100 µ 200 µ 500 µ 1m

DTC143TCA

Dimensions



A



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
Α	0.90	1.20	0.035	0.047
A1	0.00	0.10	0.000	0.004
A2	0.85	1.15	0.033	0.045
A3	0.	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.70	3.10	0.106	0.122
E	1.20	1.50	0.047	0.059
е	0.	95	0.0	37
HE	2.20	2.60	0.087	0.102
L1	0.20	a n a	0.008	800
Lp	0.30		0.012	1
Q	0.40	0.60	0.016	0.024
x	-	0.10	207	0.004
	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
h2		0.60		0.004

S

0.60 0.024 b2 1.70 0.067 e1 11 0.90 0.035 _ -

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the S	pecific Applications
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JAPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSIII	CLASSⅢ	CLASSI

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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